

Surface Mount Schottky Barrier Rectifier

Parameter	Value	Unit
V_{RRM}	20~200	V
$I_{F(AV)}$	3.0	A



DO-214AA/SMB

Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability

Applications

- For use in low-voltage, high-frequency inverters, free-wheeling applications, DC/DC converters, and polarity protection circuits.

Absolute Maximum Ratings and Characteristics (Ta=25°C unless otherwise noted)

Parameter	Symbol	SS32B	SS34B	SS36B	SS38B	SS310B	SS312B	SS315B	SS320B	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	40	60	80	100	120	150	200	V
Maximum RMS voltage	V_{RMS}	14	28	42	56	70	84	105	140	V
Maximum DC Blocking Voltage	V_{DC}	20	40	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	3.0								A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	80								A
Max Instantaneous Forward Voltage at 3A	V_F	0.55	0.70		0.85		0.95			V
Maximum DC Reverse Current Ta=25°C at Rated DC Reverse Voltage Ta=100°C	I_R	0.5 5			0.3 3					mA
Typical Junction Capacitance (1)	C_j	450			400					pF
Typical Thermal Resistance (2)	$R_{\theta JA}$	60								°C/W
Operating Junction Temperature Range	T_j	-55 ~ +150								°C
Storage Temperature Range	T_{stg}	-55 ~ +150								°C

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Typical characteristics

Fig.1 Forward Current Derating Curve

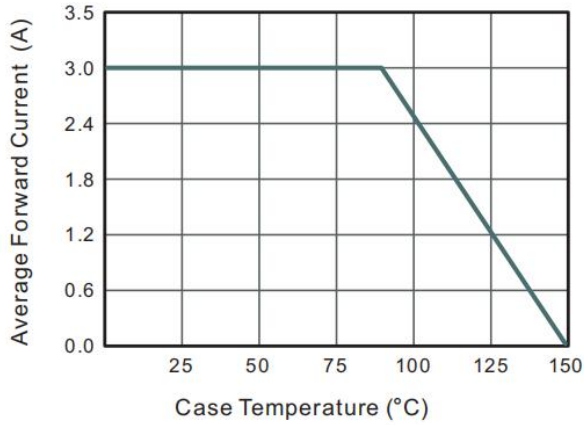


Fig.2 Typical Reverse Characteristics

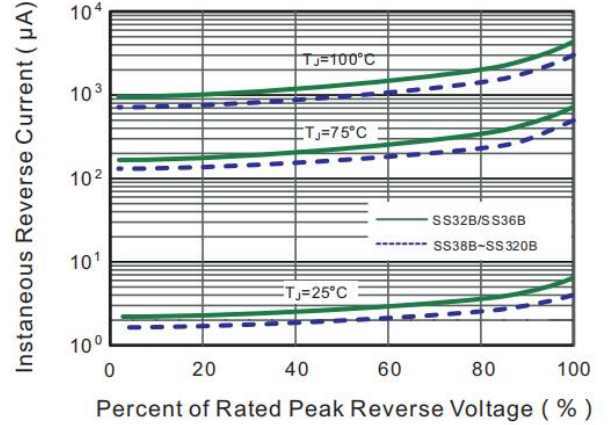


Fig.3 Typical Forward Characteristic

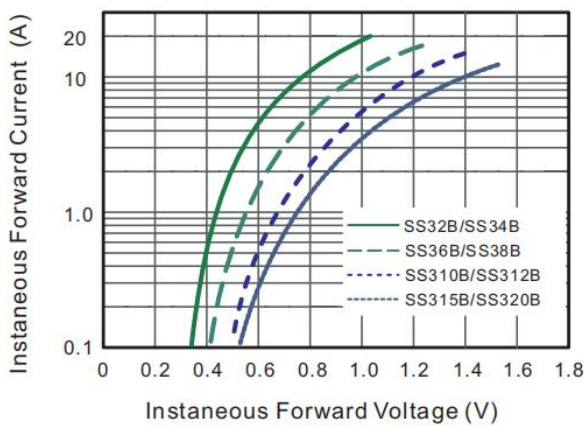


Fig.4 Typical Junction Capacitance

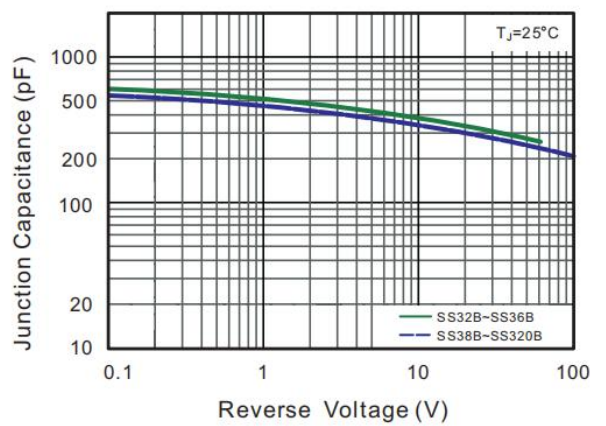


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

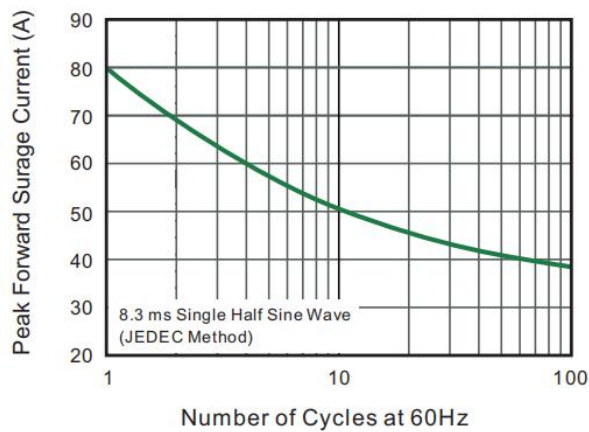
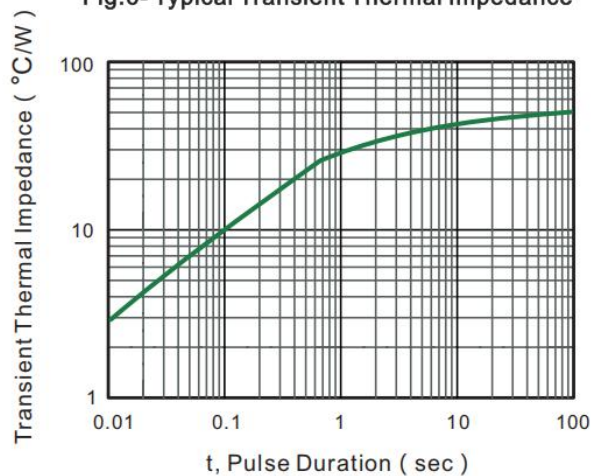


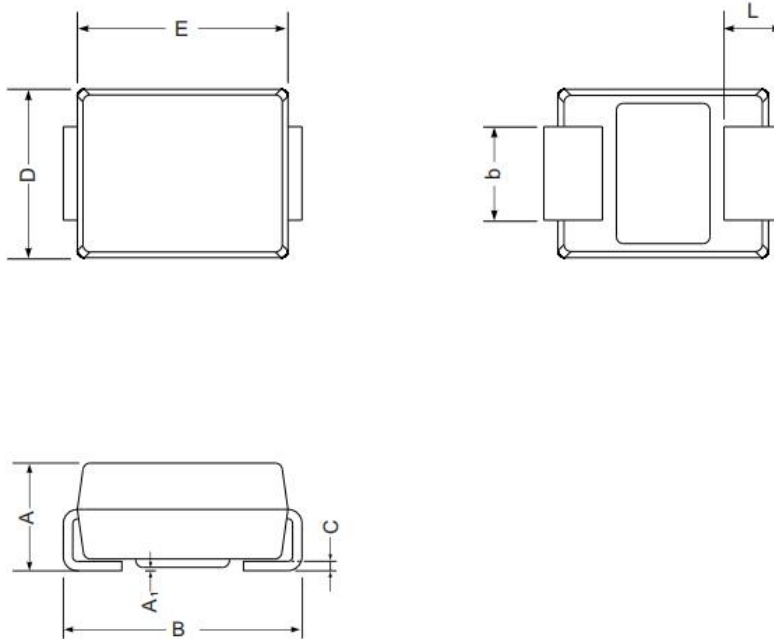
Fig.6- Typical Transient Thermal Impedance



Package Outlines

Plastic surface mounted package; 2 leads

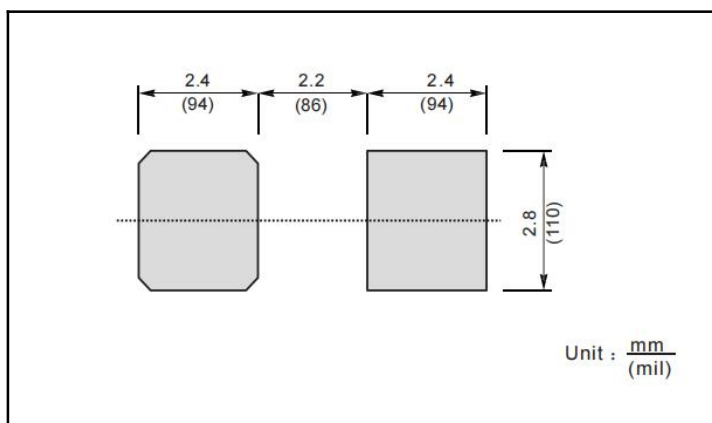
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SMB mechanical data

UNIT		A	E	D	B	A ₁	L	C	b
mm	max	2.5	4.70	3.94	5.5	0.20	1.5	0.305	2.2
	min	2.1	4.06	3.3	5.0	0.05	0.8	0.152	1.9
mil	max	98	185	155	216	7.9	59	12	87
	min	82	160	130	196	2.0	32	6	75

The recommended mounting pad size



Marking

Type number	Marking code
SS32B	SS32
SS34B	SS34
SS36B	SS36
SS38B	SS38
SS310B	SS310
SS312B	SS312
SS315B	SS315
SS320B	SS320

***Important Usage Information and Disclaimer**

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